

INTERNATIONAL JOURNAL OF HEAT AND MASS TRANSFER

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(j.w.rose@qmw.ac.uk)

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Laboratoire EM2C
École Centrale Paris
Grande Voie des Vignes
92295 Châtenay-Malabry cedex, France
(soufiani@em2c.ecp.fr)

K. SPINDLER (Associate Editor)

Institut für Thermodynamik und Wärmetechnik
Universität Stuttgart
Pfaffenwaldring 6
D-70550 Stuttgart, Germany
(spindler@itw.uni-stuttgart.de)

J. TAINÉ

Laboratoire EM2C
École Centrale Paris
Grande Voie des Vignes
92295 Châtenay-Malabry cedex, France
(taine@em2c.ecp.fr)

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Xi'an Jiaotong University
School of Energy and Power Engineering
Xi'an, Shaanxi 710049, China
(wqtao@mail.xjtu.edu.cn)

H. YOSHIDA

Kyoto University
Department of Aeronautics and Astronautics
Sakyo-ku, Kyoto 606-8501, Japan
(yoshida@mbox.kudpc.kyoto-u.ac.jp)